1.5V Drive Pch MOSFET

RZR025P01

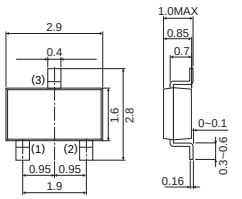
●Features
1) Low On-resistance.
2) Built-in G-S Protection Diode.
3) Small and Surface Mount Package (TSMT3).
4) Low voltage drive (1.5V).

●Application
Switching

●Structure
Silicon P-channel MOSFET

●Dimensions (Unit : mm)

TSMT3



(1) Gate
(2) Source
(3) Drain

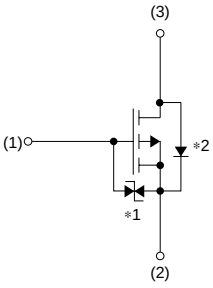
Each lead has same dimensions

Abbreviated symbol : YC

●Packaging specifications

Type	Package	Taping
	Code	TL
	Basic ordering unit (pieces)	3000
RZR025P01		○

●Equivalent circuit



∗1 ESD PROTECTION DIODE
∗2 BODY DIODE

(1) Gate
(2) Source
(3) Drain

●Absolute maximum ratings (Ta=25°C)

Parameter		Symbol	Limits	Unit
Drain-source voltage		V_{DSS}	−12	V
Gate-source voltage		V_{GSS}	±10	V
Drain current	Continuous	I_D	±2.5	A
	Pulsed	I_{DP} ∗1	±10	A
Source current (Body diode)	Continuous	I_S	−0.8	A
	Pulsed	I_{SP} ∗1	−10	A
Total power dissipation		P_D ∗2	1.0	W
Channel temperature		Tch	150	°C
Range of Storage temperature		Tstg	−55 to +150	°C

∗1 Pw≤10μs, Duty cycle≤1%
∗2 Mounted on a ceramic board

●Thermal resistance

Parameter	Symbol	Limits	Unit
Channel to ambient	Rth (ch-a) ∗	125	°C / W

∗ When mounted on a ceramic board.

●**Electrical characteristics** (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Gate-source leakage	I_{GSS}	–	–	±10	μA	V_{GS}=±10V, V_{DS}=0V
Drain-source breakdown voltage	$V_{(BR)\ DSS}$	–12	–	–	V	I_D= –1mA, V_{GS}=0V
Zero gate voltage drain current	I_{DSS}	–	–	–1	μA	V_{DS}= –12V, V_{GS}=0V
Gate threshold voltage	$V_{GS\ (th)}$	–0.3	–	–1.0	V	V_{DS}= –6V, I_D= –1mA
Static drain-source on-state resistance	$R_{DS\ (on)}$ *	–	44	61	mΩ	I_D= –2.5A, V_{GS}= –4.5V
		–	60	84	mΩ	I_D= –1.2A, V_{GS}= –2.5V
		–	81	121	mΩ	I_D= –1.2A, V_{GS}= –1.8V
		–	110	220	mΩ	I_D= –0.5A, V_{GS}= –1.5V
Forward transfer admittance	$\|Y_{fs}\|$ *	3.5	–	–	S	V_{DS}= –6V, I_D= –2.5A
Input capacitance	C_{iss}	–	1350	–	pF	V_{DS}= –6V
Output capacitance	C_{oss}	–	130	–	pF	V_{GS}=0V
Reverse transfer capacitance	C_{rss}	–	125	–	pF	f=1MHz
Turn-on delay time	$t_{d\ (on)}$ *	–	9	–	ns	I_D= –1.2A
Rise time	t_r *	–	35	–	ns	V_{DD} ≒ –6V
Turn-off delay time	$t_{d\ (off)}$ *	–	130	–	ns	V_{GS}= –4.5V
Fall time	t_f *	–	85	–	ns	R_L=5Ω
						R_G=10Ω
Total gate charge	Q_g *	–	13	–	nC	V_{DD} ≒ –6V, I_D= –2.5A
Gate-source charge	Q_{gs} *	–	2.5	–	nC	V_{GS}= –4.5V
Gate-drain charge	Q_{gd} *	–	2.0	–	nC	R_L ≒ 2.4Ω, R_G=10Ω

*Pulsed

●**Body diode characteristics**(Source-drain) (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Forward voltage	V_{SD} *	–	–	–1.2	V	I_S= –2.5A, V_{GS}=0V

* Pulsed

●**Electrical characteristic curves**

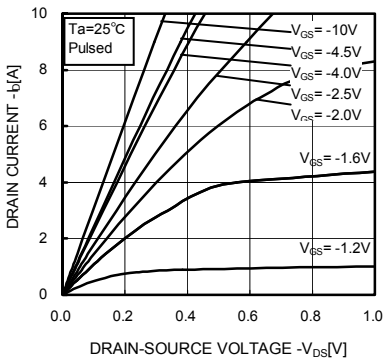


Fig.1 Typical Output Characteristics(Ⅰ)

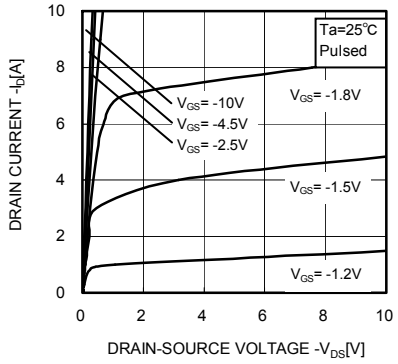


Fig.2 Typical Output Characteristics(Ⅱ)

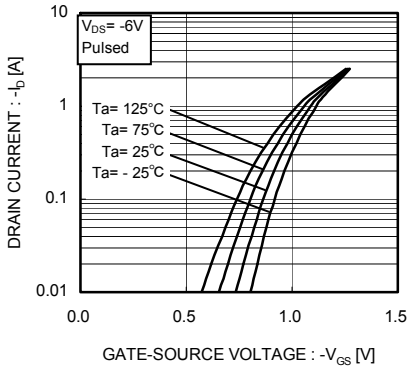


Fig.3 Typical Transfer Characteristics

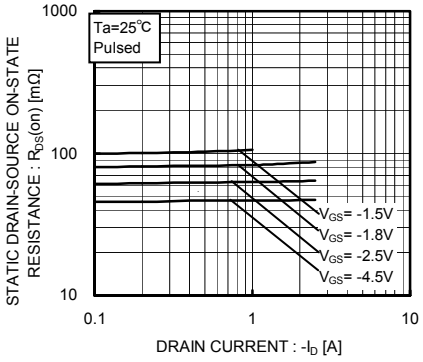


Fig.4 Static Drain-Source On-State Resistance vs. Drain Current(Ⅰ)

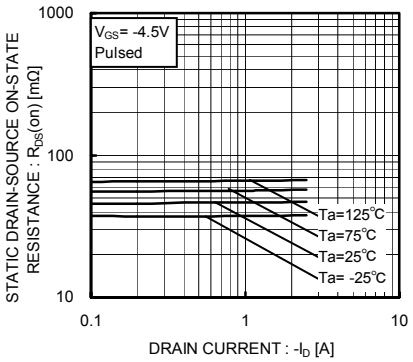


Fig.5 Static Drain-Source On-State Resistance vs. Drain Current(Ⅱ)

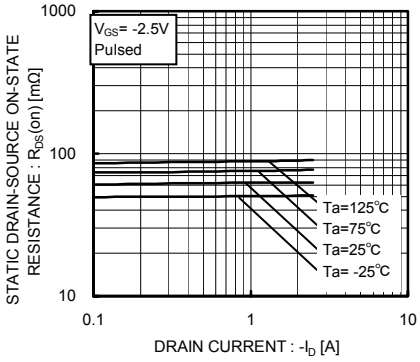


Fig.6 Static Drain-Source On-State Resistance vs. Drain Current(Ⅲ)

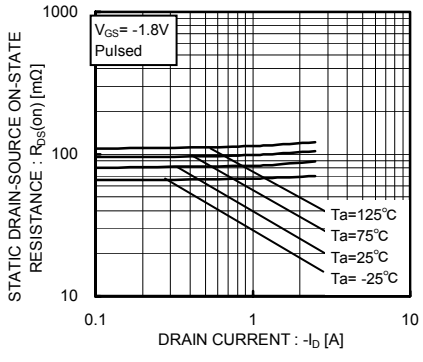


Fig.7 Static Drain-Source On-State Resistance vs. Drain Current(Ⅳ)

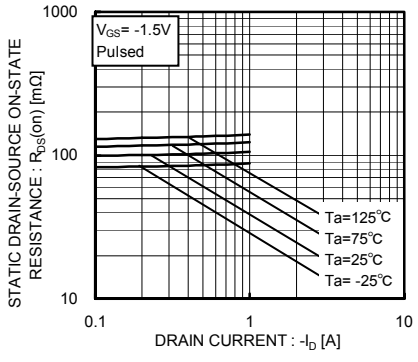


Fig.8 Static Drain-Source On-State Resistance vs. Drain Current(Ⅳ)

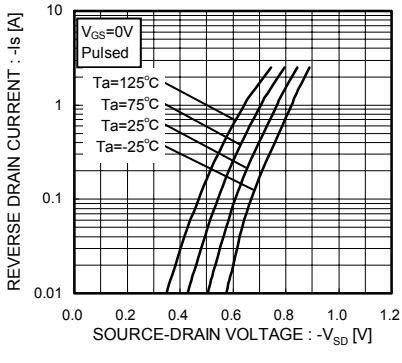


Fig.9 Reverse Drain Current vs. Sourse-Drain Voltage

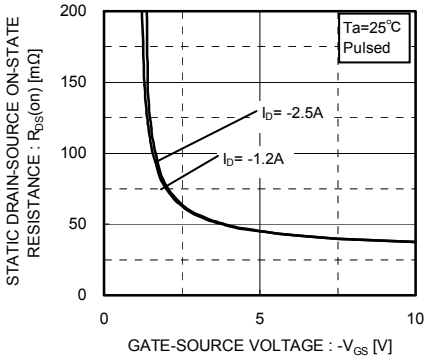


Fig.10 Static Drain-Source On-State Resistance vs. Gate Source Voltage

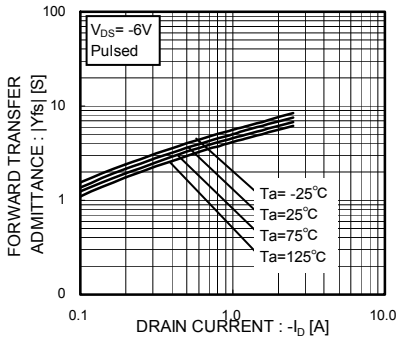


Fig.11 Forward Transfer Admittance vs. Drain Current

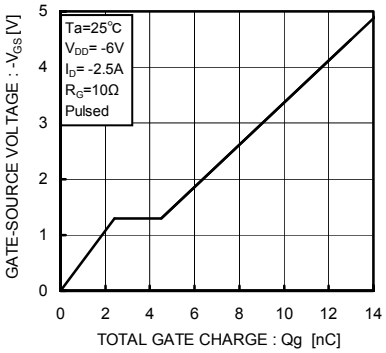


Fig.12 Dynamic Input Characteristics

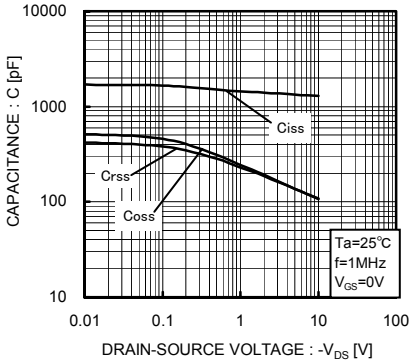


Fig.13 Typical Capacitance vs. Drain-Source Voltage

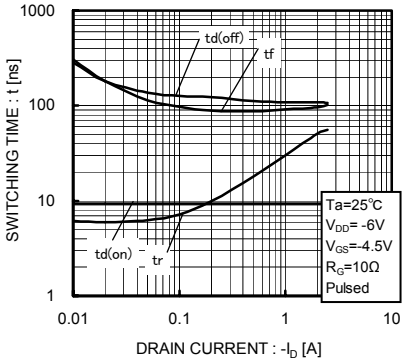


Fig.14 Switching Characteristics

●**Measurement circuits**

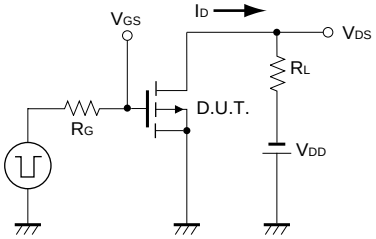


Fig.15 Switching Time Test Circuit

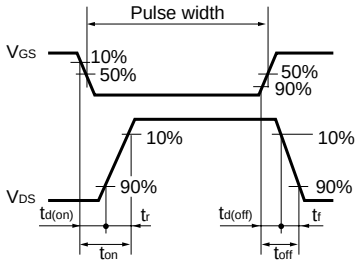


Fig.16 Switching Time Waveforms

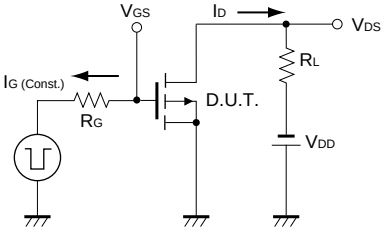


Fig.17 Gate Charge Test Circuit

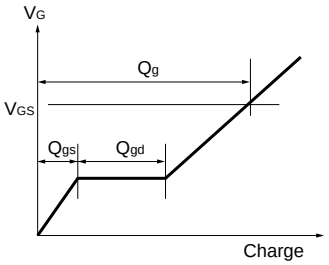


Fig.18 Gate Charge Waveform

●**Notice**

This product might cause chip aging and breakdown under the large electrified environment.
Please consider to design ESD protection circuit.

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